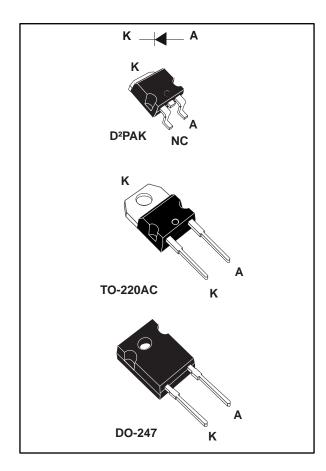


STTH15RQ06

Turbo 2 ultrafast high voltage rectifier

Datasheet - production data



Description

The STTH15RQ06 has been developed to be used in application requiring a high-voltage secondary rectification for LLC Full Bridge topology.

It is also suited for use in switching power supplies, industrial applications, as rectification, freewheeling and clamping diode.

Table 1: Device summary

Symbol	Value
I _{F(AV)}	15A
V_{RRM}	600 V
V _F (max.)	1.45 V
t _{rr} (max.)	25 ns
T _j (max.)	+175 °C

Features

- High junction temperature capability
- Ultrafast with soft recovery behavior
- Low reverse current
- Low thermal resistance
- Reduce switching and conduction losses

Characteristics STTH15RQ06

Characteristics 1

Table 2: Absolute ratings (limiting values, at 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	600	V	
I _{F(RMS)}	Forward rms current	50	Α	
I _{F(AV)}	Average forward current δ = 0.5, square wave T_C = 115 °C		15	Α
I _{FSM}	Surge non repetitive forward current	120	Α	
T _{stg}	Storage temperature range	-65 to +175	°C	
Tj	Maximum operating junction temperature		175	°C

Table 3: Thermal parameters

Symbol	Parameter	Max. value	Unit
R _{th(j-c)}	Junction to case	1.5	°C/W

Table 4: Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
1 (1)	I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	-		20	μΑ
IR'''		T _j = 150 °C	$V_R = V_{RRM}$	-	40	400	
		T _j = 25 °C	I _F = 7.5 A	-		2.45	
V (2)	V _F ⁽²⁾ Forward voltage drop	T _j = 150 °C		-	1.15	1.45	V
VF ⁽²⁾		T _j = 25 °C	I_ 4ΕΛ	-		2.95	V
		T _j = 150 °C	I _F = 15 A	-	1.45	1.85	

Notes:

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 $^{(1)}\text{Pulse}$ test: t_p = 5 ms, δ < 2%

 $^{(2)}$ Pulse test: tp = 380 µs, δ < 2%

To evaluate the conduction losses, use the following equation:

 $P = 1.05 \text{ x } I_{F(AV)} + 0.053 \text{ x } I_{F^{2}(RMS)}$

Table 5: Dynamic electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit	
			I _F = 0.5 A I _R = 1 A I _{rr} = 0.25 A	ı		25	20	
Lrr	t _{rr} Reverse recovery time	$T_{j} = 25 \text{ °C}$ $I_{F} = 1 \text{ A}$ $V_{R} = 30 \text{ V}$ $dI_{F}/dt = -50 \text{ A}$		ı	35	50	ns	
I _{RM}	Reverse recovery current		I _F = 15 A	ı	6	8	Α	
Q _{RR}	Reverse recovery charge	T _j = 125 °C	T _j = 125 °C	V _R = 400 V	-	250		nC
t _{rr}	Reverse recovery time		$dI_F/dt = -200 A/\mu s$	-	70		ns	

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STTH15RQ06 Characteristics

1.1 Characteristics (curves)

Figure 1: Average forward power dissipation versus average forward current (square waveform)

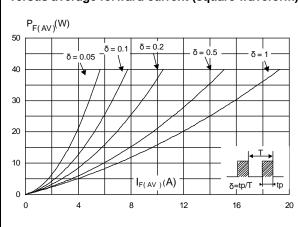


Figure 2: Average forward power dissipation versus average forward current (sinusoidal waveform)

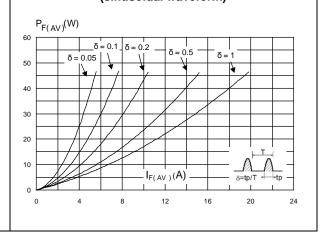


Figure 3: Forward voltage drop versus forward current (typical values)

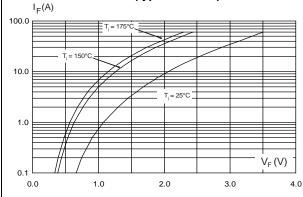


Figure 4: Forward voltage drop versus forward current (maximum values)

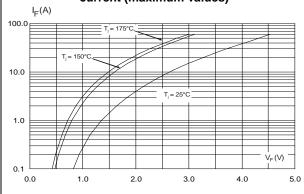


Figure 5: Relative variation of thermal impedance junction to case versus pulse duration

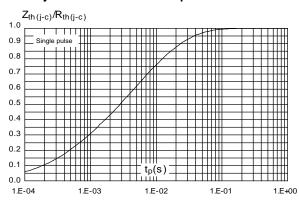
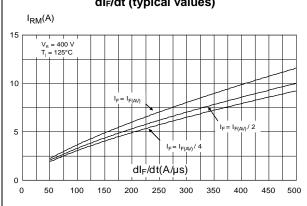


Figure 6: Peak reverse recovery current versus dlr/dt (typical values)





Characteristics STTH15RQ06

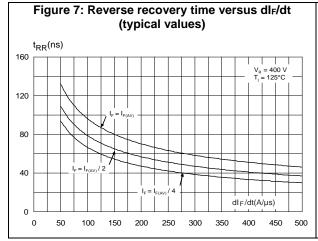


Figure 8: Reverse recovery charges versus dl_F/dt (typical values) Q_{RR}(nC) 500 V_R = 400 V T_i = 125°C 400 300 200 100 dI_F/dt(A/µs) 0 0 50 100 150 200 250 300 350 400 450 500

Figure 9: Reverse recovery softness factor versus dl_F/dt (typical values)

S_{factor}

2.0

1.6

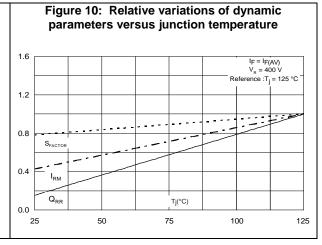
1.2

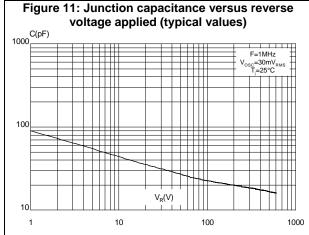
0.8

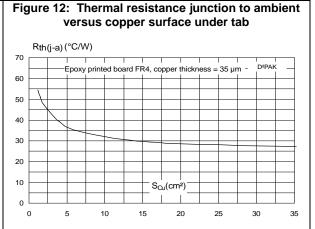
0.4

0.0

0 50 100 150 200 250 300 350 400 450 500







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STTH15RQ06 Characteristics

Figure 13: Relative variation of non-repetitive peak surge forward current versus pulse duration (sinusoidal waveform)

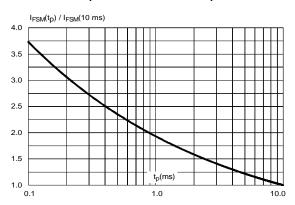
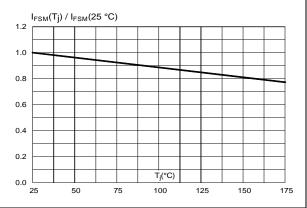


Figure 14: Relative variation of non-repetitive peak surge forward current versus initial junction temperature (sinusoidal waveform)



2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.55 N·m (TO-220AC)
- Recommended torque value: 0.8 N·m (DO-247)
- Maximum torque value: 0.7 N·m (TO-220AC)
- Maximum torque value: 1.0 N·m (DO-247)

STTH15RQ06 Package information

2.1 DO-247 package information

Figure 15: DO-247 package outline

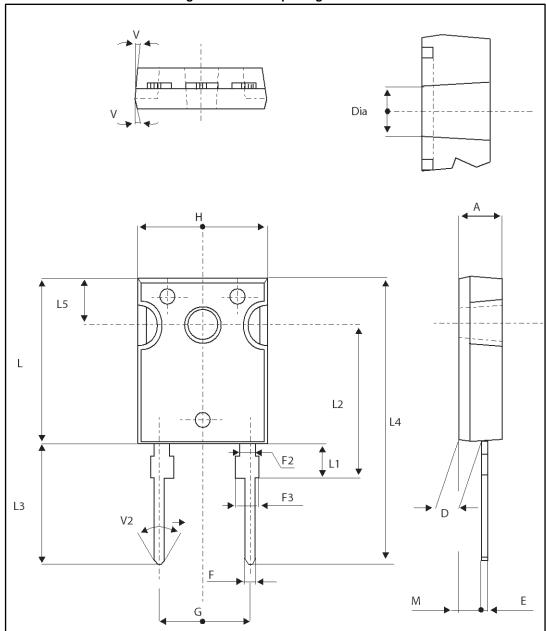


Table 6: DO-247 package mechanical data

	Dimensions				
Ref.	Millim	eters	Incl	hes	
	Min.	Max.	Min.	Max.	
Α	4.85	5.15	0.191	0.203	
D	2.20	2.60	0.086	0.102	
E	0.40	0.80	0.015	0.031	
F	1.00	1.40	0.039	0.055	
F2	2.00	typ.	0.078	3 typ.	
F3	2.00	2.40	0.078	0.094	
G	10.90	typ.	0.429 typ.		
Н	15.45	15.75	0.608	0.620	
L	19.85	20.15	0.781	0.793	
L1	3.70	4.30	0.145	0.169	
L2	18.50	typ.	0.728	3 typ.	
L3	14.20	14.80	0.559	0.582	
L4	34.60	typ.	1.362	2 typ.	
L5	5.50 typ.		0.216	S typ.	
M	2.00	3.00	0.078	0.118	
V	5°		5	0	
V2	60)°	60)°	
Dia.	3.55	3.65	0.139	0.143	

STTH15RQ06 Package information

2.2 D²PAK package information

Figure 16: D²PAK package outline

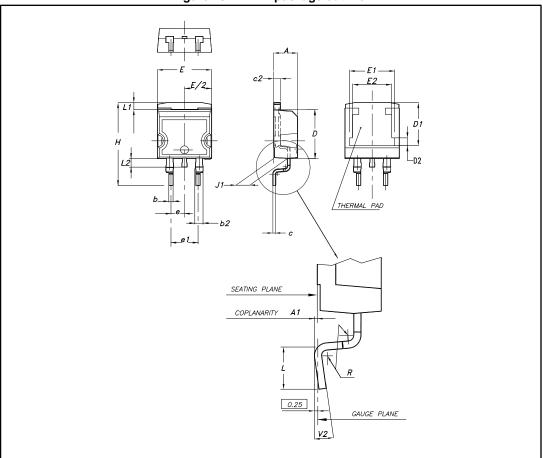




Table 7: D²PAK package mechanical data

		Table 7. L		mechanicai da	ııa	
	Dimensions					
Ref.		Millimeters	S		Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	4.40		4.60	0.173		0.181
A1	0.03		0.23	0.001		0.009
b	0.70		0.93	0.028		0.037
b2	1.14		1.70	0.045		0.067
С	0.45		0.60	0.018		0.024
c2	1.23		1.36	0.048		0.053
D	8.95		9.35	0.352		0.368
D1	7.50	7.75	8.00	0.295	0.305	0.315
D2	1.10	1.30	1.50	0.043	0.051	0.060
Е	10		10.40	0.394		0.409
E1	8.50	8.70	8.90	0.335	0.343	0.346
E2	6.85	7.05	7.25	0.266	0.278	0.282
е		2.54			0.100	
e1	4.88		5.28	0.190		0.205
Н	15		15.85	0.591		0.624
J1	2.49		2.69	0.097		0.106
L	2.29		2.79	0.090		0.110
L1	1.27		1.40	0.049		0.055
L2	1.30		1.75	0.050		0.069
R		0.4			0.015	
V2	0°		8°	0°		8°

STTH15RQ06 Package information

9.75

16.9

1.6

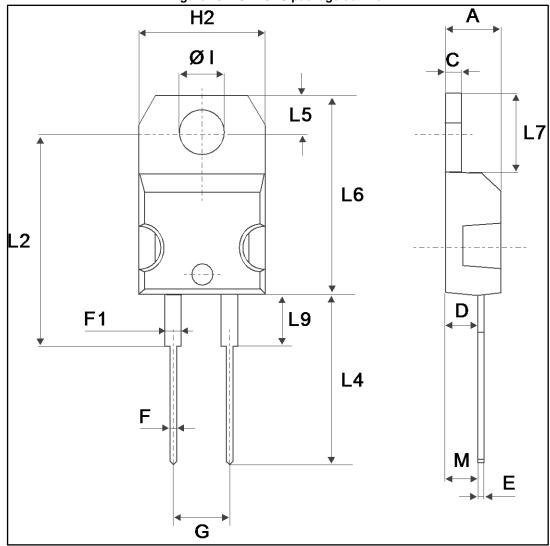
2.54

5.08

Figure 17: D²PAK recommended footprint (dimensions are in mm)

2.3 TO-220AC package information

Figure 18: TO-220AC package outline



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Table 8: TO-220AC package mechanical data

	Dimensions				
Ref.	Millim	neters	Inch	ies	
	Min.	Max.	Min.	Max.	
А	4.40	4.60	0.173	0.181	
С	1.23	1.32	0.048	0.051	
D	2.40	2.72	0.094	0.107	
E	0.49	0.70	0.019	0.027	
F	0.61	0.88	0.024	0.034	
F1	1.14	1.70	0.044	0.066	
G	4.95	5.15	0.194	0.202	
H2	10.00	10.40	0.393	0.409	
L2	16.40) typ.	0.645	typ.	
L4	13.00	14.00	0.511	0.551	
L5	2.65	2.95	0.104	0.116	
L6	15.25	15.75	0.600	0.620	
L7	6.20	6.60	0.244	0.259	
L9	3.50	3.93	0.137	0.154	
М	2.6	typ.	0.102	typ.	
ØI	3.75	3.85	0.147	0.151	



Ordering information STTH15RQ06

3 Ordering information

Table 9: Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STTH15RQ06G-TR	STTH15RQ06G	D²PAK	1.38 g	1000	Tape and reel
STTH15RQ06D	STTH15RQ06D	TO-220AC	1.86 g	50	Tube
STTH15RQ06W	STTH15RQ06W	DO-247	4.40 g	30	Tube

4 Revision history

Table 10: Document revision history

Date	Revision	Changes
12-Jun-2017	1	Initial release.

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